

## AMENDMENTS TO THE SPECIFICATION

Please amend paragraph 0034, on page 15, as follows.

[0034] FIG. 10 is a front perspective drawing showing the detailed structure of a power supply in accordance with an embodiment of the present invention. A power supply 10k has an air flow generator 18a that creates an air flow throughout the power supply 10k. The air flow generator 18a is disposed between a first circuit 26a 26 and a second circuit 28a 28. Cooling structures 22e are disposed within the power supply 10k. The cooling structures 22e are thermally coupled to the various heat-producing components within the power supply 10k.

Please amend paragraph 0035, on page 15, as follows.

[0035] The cooling structures typically have a “flow” face (generally parallel to the flow of the air created by the air flow generator 18) and an “impedance” face (generally perpendicular to the flow of air and creating a higher flow impedance than the “flow” face). In one aspect of the invention, the combined areas of the flow impedance faces are dominated by the combined areas of the flow faces. In such a power supply, the combined areas of the flow faces can be four times higher, or greater, than the combined areas of the impedance faces of the cooling structures.